Si4124DY

RoHS

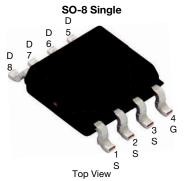
COMPLIANT

HALOGEN

FREE

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Vishay Siliconix



PRODUCT SUMMARY					
V _{DS} (V)	40				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.0075				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.0090				
Q _g typ. (nC)	21				
I _D (A) ^d	20.5				
Configuration	Single				

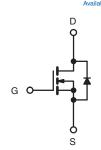
FEATURES

N-Channel 40 V (D-S) MOSFET

- TrenchFET[®] power MOSFET
- 100 % R_g tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Synchronous rectification
- DC/DC



N-Channel MOSFET

ORDERING INFORMATION			
Package	SO-8		
Lead (Pb)-free	Si4124DY-T1-E3		
Lead (Pb)-free and halogen-free	Si4124DY-T1-GE3		

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	40	V	
Gate-source voltage		V _{GS}	±20	v	
	T _C = 25 °C		20.5		
Continuous durin comment (T. 150 °C)	T _C = 70 °C	1.	16.4		
Continuous drain current ($T_J = 150 \ ^\circ C$)	T _A = 25 °C	I _D	13.6 ^{a, b}	•	
	T _A = 70 °C	-	10.9 ^{a, b}	— A	
Pulsed drain current		I _{DM}	50		
Avalanche current		I _{AS}	33		
Avalanche energy	L = 0.1 mH	E _{AS}	54	mJ	
Continuous source-drain diode current	T _C = 25 °C	I _S	4.7	•	
	T _A = 25 °C		2.1 ^{a, b}	— A	
Maximum power dissipation	T _C = 25 °C	P _D	5.7		
	T _C = 70 °C		3.6	14/	
	T _A = 25 °C		2.5 ^{a, b}	W	
	T _A = 70 °C		1.6 ^{a, b}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient ^{a, c}	$t \le 10 s$	R _{thJA}	39	50	°C/W	
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	18	22	C/W	

Notes

a. Surface mounted on 1" x 1" FR4 board

b. t = 10 s

c. Maximum under steady state conditions is 85 °C/W

d. Based on T_C = 25 $^\circ C$

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Si4124DY

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•		•		
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	40	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	46	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-6.7	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1	-	3	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	±100	nA	
		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	1 5 μΑ	
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$	-	-	5		
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	50	-	-	А	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 14 \text{ A}$	-	0.0062	0.0075)75	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 12 A	-	0.0073	0.0090	Ω	
Forward transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 16 A	-	55	-	S	
Dynamic ^b							
Input capacitance	C _{iss}		-	3540	-	pF	
Output capacitance	C _{oss}	V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHz	-	335	-		
Reverse transfer capacitance	C _{rss}		-	142	-		
Total gate charge	Qg	$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 16 \text{ A}$	-	51	77	nC	
		· · · · · -	-	21	32		
Gate-source charge	Q _{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 16 \text{ A}$	-	10.7	-		
Gate-drain charge	Q _{qd}		-	3.0	-		
Gate resistance	R _g	f = 1 MHz	-	0.75	1.5	Ω	
Turn-on delay time	t _{d(on)}		-	30	45		
Rise time	t _r	$V_{DD} = 20 \text{ V}, \text{ R}_1 = 2 \Omega$	-	14	21		
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ Å}, V_{\text{GEN}} = 4.5 \text{V}, \text{R}_\text{g} = 1 \Omega$	-	38	60		
Fall time	t _f		-	11	17		
Turn-on delay time	t _{d(on)}		-	14	21	ns	
Rise time	t _r	$V_{DD} = 20 \text{ V}, \text{ R}_{\text{I}} = 2 \Omega$	-	10	15		
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ Å}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	32	50		
Fall time	t _f		-	8	15		
Drain-Source Body Diode Characterist	cs		1		1		
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	32		
Pulse diode forward current	I _{SM}		-	-	50	A	
Body diode voltage	V _{SD}	I _S = 10 A, V _{GS} = 0 V	-	0.8	1.2	V	
Body diode reverse recovery time	t _{rr}		-	25	50	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = 10 A, di/dt = 100 A/μs,	-	19	38	nC	
Reverse recovery fall time	t _a	$T_J = 25 \ ^\circ C$	-	13	-		
Reverse recovery rise time	t _b		-	12	-	ns	

Notes

a. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$

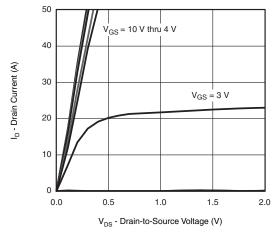
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

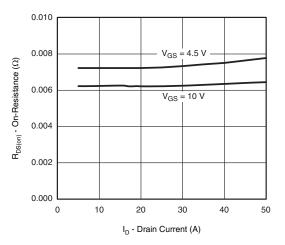
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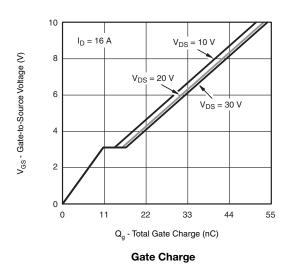
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

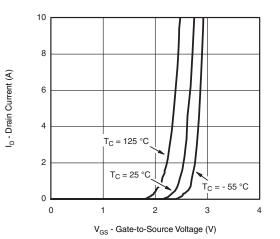




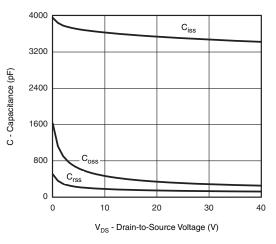


On-Resistance vs. Drain Current and Gate Voltage

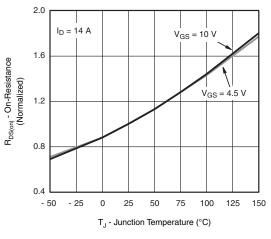




Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

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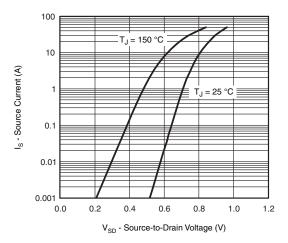
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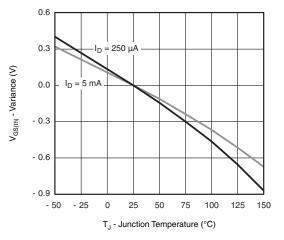
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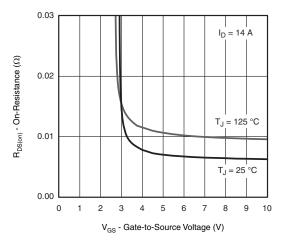
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



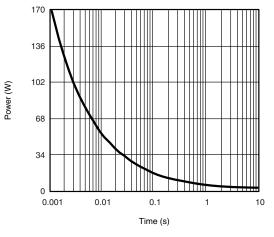
Source-Drain Diode Forward Voltage



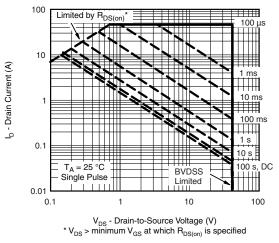
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



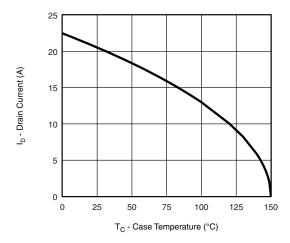
Single Pulse Power (Junction-to-Ambient)



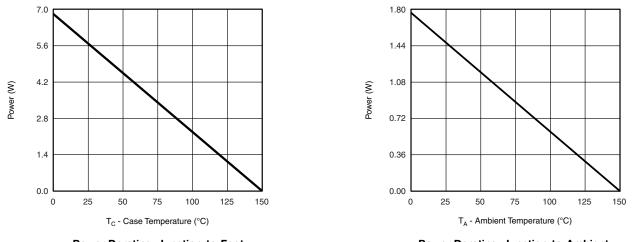
Safe Operating Area, Junction-to-Ambient

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







Power Derating, Junction-to-Foot

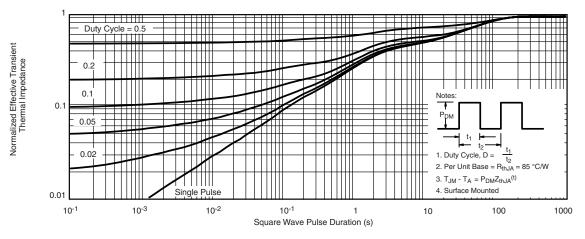


Note

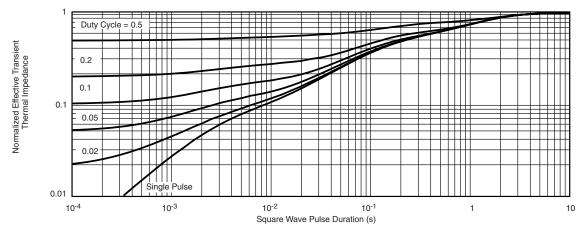
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	HES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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